

# **MOSFET**

# 500V CoolMOS™ CE Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ CE is a price-performance optimized platform enabling to target cost sensitive applications in Consumer and Lighting markets by still meeting highest efficiency standards. The new series provides all benefits of a fast switching Superjunction MOSFET while not sacrificing ease of use and offering the best cost down performance ratio available on the market.

# DPAK tab

# **Features**

- Extremely low losses due to very low FOM Rdson\*Qg and Eoss
- Very high commutation ruggedness
- Easy to use/drive
- Pb-free plating, Halogen free mold compound
- Qualified for standard grade applications

# **Applications**

PFC stages, hard switching PWM stages and resonant switching stages for e.g. PC Silverbox, Adapter, LCD & PDP TV and indoor lighting.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended



Gate





Table 1 Rey Feriorillance Farameters								
Parameter	Value	Unit	Unit					
V <sub>DS</sub> @ T <sub>j,max</sub>	550	V						
R <sub>DS(on),max</sub>	0.28	Ω						
I <sub>D</sub>	18.1	A						
$Q_{g,typ}$	32.6	nC						
I <sub>D,pulse</sub>	42.9	A						
E <sub>oss</sub> @ 400V	3.2	μJ						



Source

Type / Ordering Code	Package	Marking	Related Links
IPD50R280CE	PG-TO 252	50S280CE	see Appendix A

# 500V CoolMOS™ CE Power Transistor IPD50R280CE



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# **500V CoolMOS™ CE Power Transistor**

IPD50R280CE



1 Maximum ratings at  $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Oh a l	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	<b>I</b> D		18.1 11.4	А	T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C		
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	42.9	Α	T <sub>C</sub> =25°C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	231	mJ	I <sub>D</sub> =5.2A; V <sub>DD</sub> = 50V	
Avalanche energy, repetitive	<b>E</b> AR	-	-	0.35	mJ	I <sub>D</sub> =5.2A; V <sub>DD</sub> = 50V	
Avalanche current, repetitive	I <sub>AR</sub>	-	-	5.2	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	50	V/ns	V <sub>DS</sub> =0400V	
Gate source voltage	V <sub>GS</sub>	-20 -30	-	20 30	V	static; AC (f>1 Hz)	
Power dissipation (non FullPAK) TO-252	P <sub>tot</sub>	-	-	119	W	T <sub>C</sub> =25°C	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	-	
Continuous diode forward current	Is	-	-	12.8	Α	T <sub>C</sub> =25°C	
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	-	-	42.9	Α	T <sub>C</sub> = 25°C	
Reverse diode dv/dt <sup>3)</sup>	dv/dt	-	-	15	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$ , $T_{\rm j}$ =25°C $t_{\rm cond}$ <2 $\mu$ s	
Maximum diode commutation speed <sup>3)</sup>	di <sub>f</sub> /dt	-	-	500	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$ , $T_{\rm j}$ =25°C $t_{\rm cond}$ <2 $\mu$ s	

### **Thermal characteristics** 2

Thermal characteristics (non FullPAK) TO-252 Table 3

Parameter	Symbol		Values	i	Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Offic		
Thermal resistance, junction - case	<b>R</b> thJC	-	-	1.05	°C/W	-	
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	62	°C/W	leaded	
Soldering temperature, wavesoldering only allowed at leads	$T_{sold}$	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

 $<sup>^{1)}</sup>$  Limited by T<sub>j max</sub> <150°C, Maximum Duty Cycle D = 0.5  $^{2)}$  Pulse width t<sub>p</sub> limited by T<sub>j,max</sub>  $^{3)}$  V<sub>DClink</sub>=400V; V<sub>DS,peak</sub><V<sub>(BR)DSS</sub>; identical low side and high side switch with identical  $R_{\rm G}$ 

# 500V CoolMOS™ CE Power Transistor IPD50R280CE



# 3 Electrical characteristics

**Table 4** Static characteristics

Danier de la constante de la c	Or made at		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	500	-	-	V	$V_{GS}$ =0V, $I_D$ =1mA
Gate threshold voltage	$V_{(\mathrm{GS})\mathrm{th}}$	2.50	3	3.50	V	$V_{\rm DS}$ = $V_{\rm GS}$ , $I_{\rm D}$ =0.35mA
Zero gate voltage drain current	I <sub>DSS</sub>	-	- 10	1 -	μΑ	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C V <sub>DS</sub> =500V, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C
Gate-source leakage curent	I <sub>GSS</sub>	-	-	100	nA	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.25 0.66	0.28	Ω	V <sub>GS</sub> =13V, I <sub>D</sub> =4.2A, T <sub>j</sub> =25°C V <sub>GS</sub> =13V, I <sub>D</sub> =4.2A, T <sub>j</sub> =150°C
Gate resistance	R <sub>G</sub>	-	3	-	Ω	f=1 MHz, open drain

 Table 5
 Dynamic characteristics

Parameter.	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	C <sub>iss</sub>	-	773	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =100V, f=1MHz	
Output capacitance	Coss	-	49	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =100V, f=1MHz	
Effective output capacitance, energy related <sup>1)</sup>	C <sub>o(er)</sub>	-	40	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V	
Effective output capacitance, time related <sup>2)</sup>	C <sub>o(tr)</sub>	-	173	-	pF	I <sub>D</sub> =constant, V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V	
Turn-on delay time	t <sub>d(on)</sub>	-	8	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =5.2A, $R_{\rm G}$ =3.4 $\Omega$	
Rise time	t <sub>r</sub>	-	6.4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =5.2A, $R_{\rm G}$ =3.4 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	40	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =5.2A, $R_{\rm G}$ =3.4 $\Omega$	
Fall time	t <sub>f</sub>	-	7.6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13 V, $I_{\rm D}$ =5.2A, $R_{\rm G}$ =3.4 $\Omega$	

Table 6 Gate charge characteristics

Parameter	Symbol		Values		Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	4.2	-	nC	$V_{DD}$ =400V, $I_{D}$ =5.2A, $V_{GS}$ =0 to 10V
Gate to drain charge	$Q_{gd}$	-	17.1	-	nC	$V_{DD}$ =400V, $I_{D}$ =5.2A, $V_{GS}$ =0 to 10V
Gate charge total	<b>Q</b> g	-	32.6	-	nC	$V_{DD}$ =400V, $I_{D}$ =5.2A, $V_{GS}$ =0 to 10V
Gate plateau voltage	V <sub>plateau</sub>	-	5.3	_	V	$V_{DD}$ =400V, $I_{D}$ =5.2A, $V_{GS}$ =0 to 10V

 $<sup>^{1)}</sup>$   $C_{\text{o(er)}}$  is a fixed capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 80%  $V_{\text{(BR)DSS}}$   $^{2)}$   $C_{\text{o(tr)}}$  is a fixed capacitance that gives the same charging time as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 80%  $V_{\text{(BR)DSS}}$ 

# **500V CoolMOS™ CE Power Transistor**

IPD50R280CE

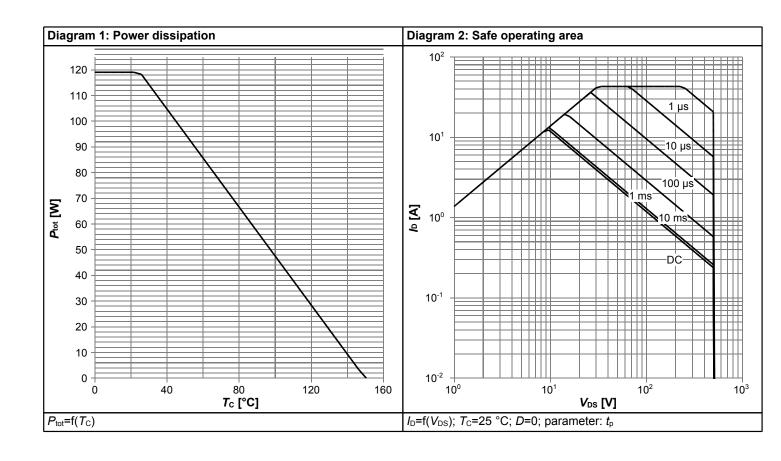


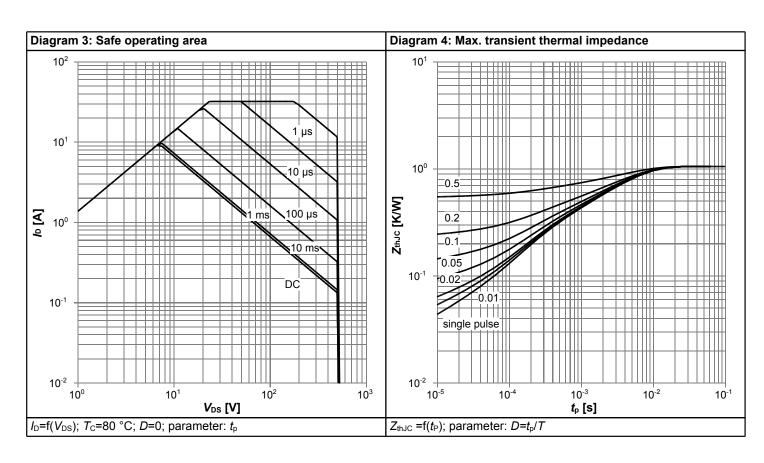
# Table 7 Reverse diode characteristics

Davamatar	Cumbal		Values		Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode forward voltage	V <sub>SD</sub>	-	0.85	-	V	V <sub>GS</sub> =0V, I <sub>F</sub> =5.2A, T <sub>f</sub> =25°C	
Reverse recovery time	t <sub>rr</sub>	-	230	-	ns	V <sub>R</sub> =400V, I <sub>F</sub> =5.2A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100A/μs	
Reverse recovery charge	Qrr	-	2.2	-	μC	V <sub>R</sub> =400V, I <sub>F</sub> =5.2A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100A/μs	
Peak reverse recovery current	I <sub>rrm</sub>	-	17.5	-	Α	V <sub>R</sub> =400V, I <sub>F</sub> =5.2A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100A/μs	

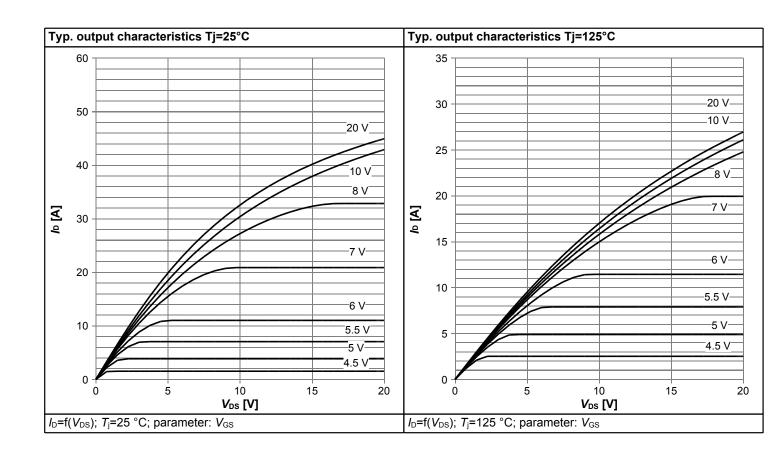


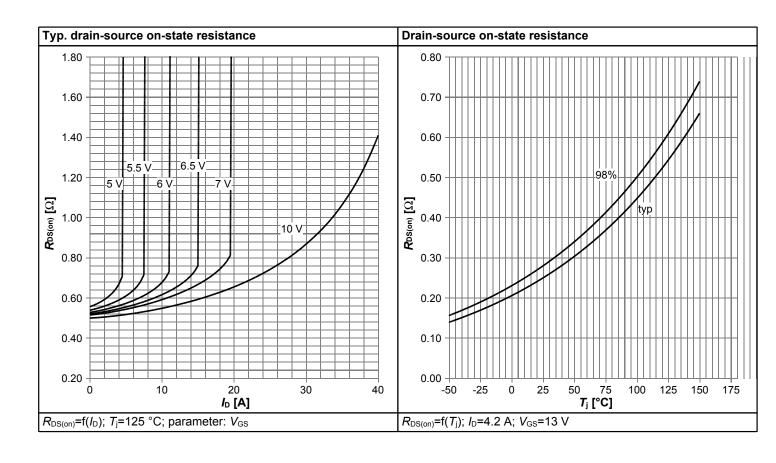
# 4 Electrical characteristics diagrams



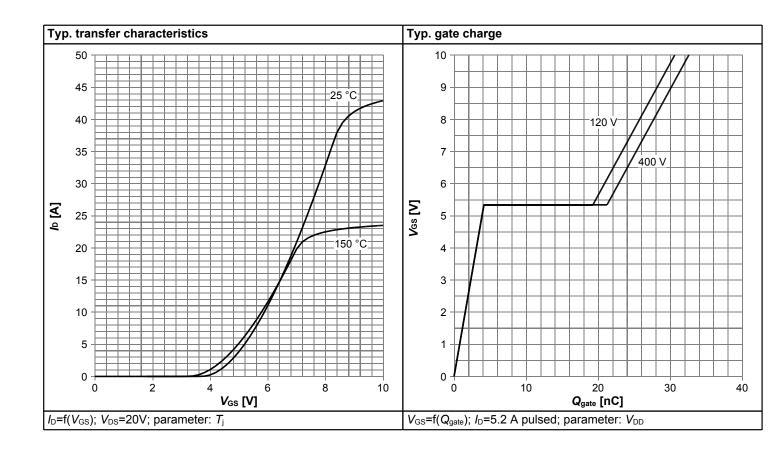


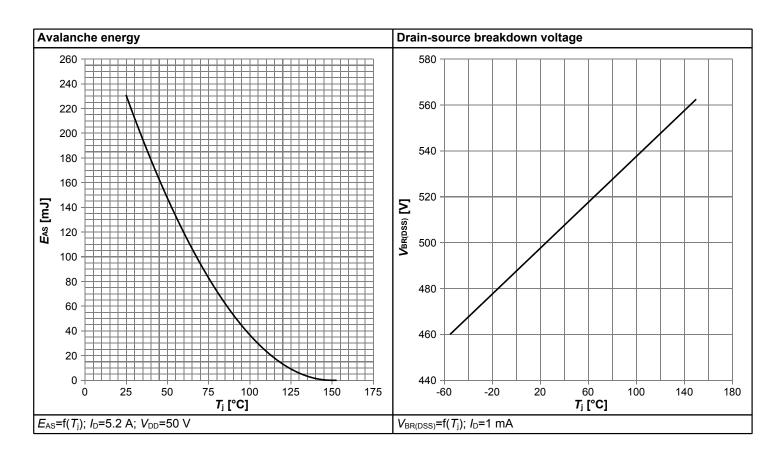




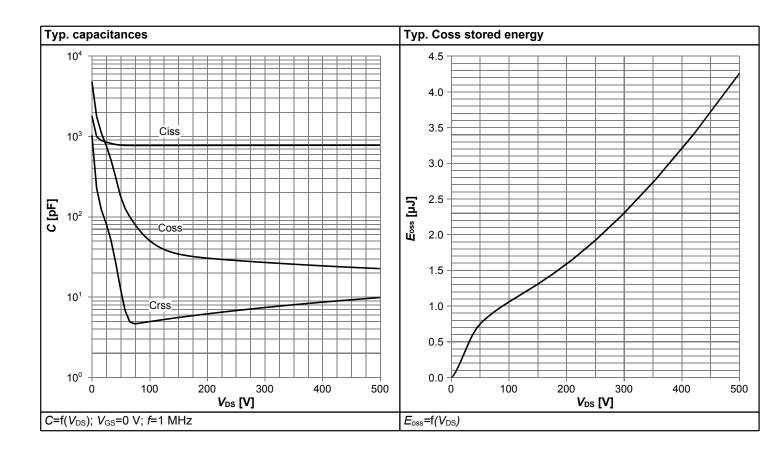


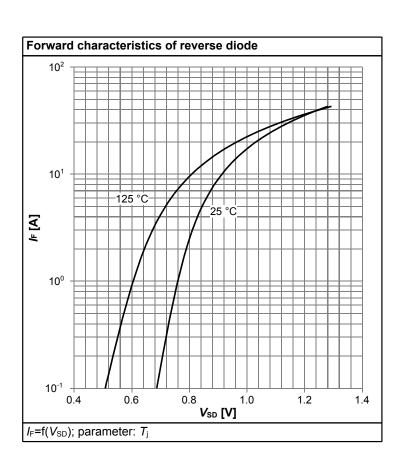














# 5 Test Circuits

**Table 8** Diode characteristics

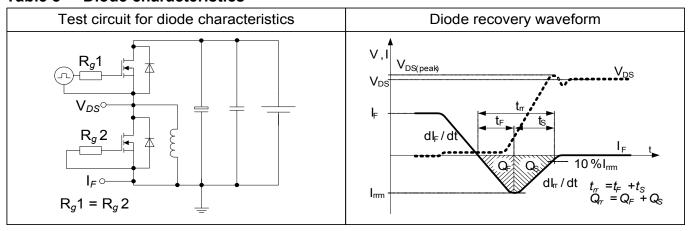


Table 9 Switching times

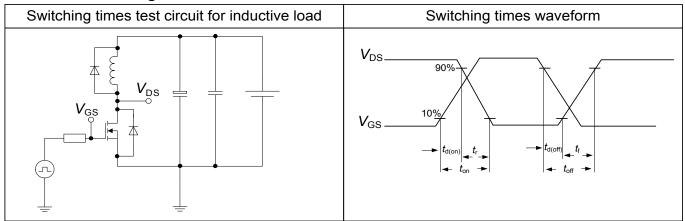
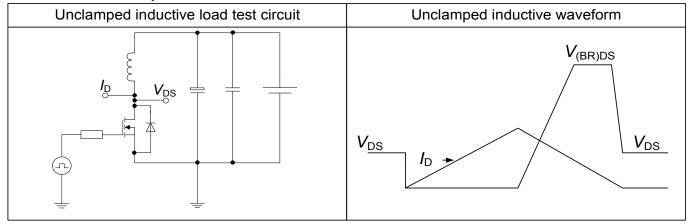
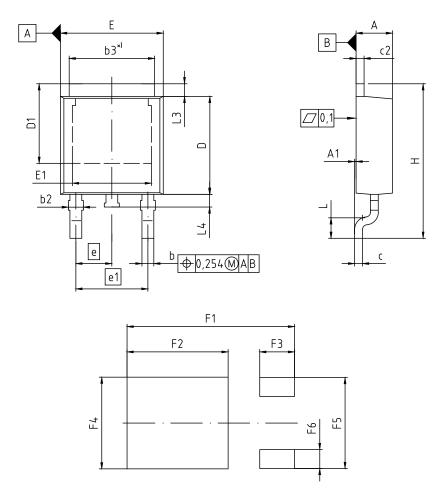


Table 10 Unclamped inductive load





# 6 Package Outlines



\*) mold flash not included

DIM	MILLIN	METERS	INCI	HES		
DIN	MIN	MAX	MIN	MAX		
Α	2.16	2.41	0.085	0.095		
A1	0.00	0.15	0.000	0.006		
b	0.64	0.89	0.025	0.035		
b2	0.65	1.15	0.026	0.045		
b3	5.00	5.50	0.197	0.217		
С	0.46	0.60	0.018	0.024		
c2	0.46	0.98	0.018	0.039		
D	5.97	6.22	0.235	0.245		
D1	5.02	5.84	0.198	0.230		
E	6.40	6.73	0.252	0.265		
E1	4.70	5.60	0.185	0.220		
е	2	.29 (BSC)	0.0	090 (BSC)		
e1	4	.57 (BSC)	0.180 (BSC)			
N		3	3			
Н	9.40	10.48	0.370	0.413		
L	1.18	1.70	0.046	0.067		
L3	0.90	1.25	0.035	0.049		
L4	0.51	1.00	0.020	0.039		
F1	10	0.60	0.4	117		
F2	6	6.40	0.2	252		
F3	2	2.20	0.0	087		
F4	5	5.80	0.2	228		
F5	5	5.76	0.2	227		
F6	1	.20	0.0	047		

SCALE 0
2.0
0 2.0
4mm

EUROPEAN PROJECTION

ISSUE DATE
01-09-2015

REVISION
05

Figure 1 Outline PG-TO 252, dimensions in mm/inches

# 500V CoolMOS™ CE Power Transistor IPD50R280CE



# 7 Appendix A

# Table 11 Related Links

• IFX CoolMOS Webpage: www.infineon.com

• IFX Design tools: www.infineon.com

# 500V CoolMOS™ CE Power Transistor

### IPD50R280CE



### **Revision History**

IPD50R280CE

Revision: 2016-06-13, Rev. 2.3

### **Previous Revision**

Revision	Date	Subjects (major changes since last revision)
2.0	2012-06-29	Release of final version
2.1	2013-07-15	update to Halogen free mold compound
2.2	2015-11-17	Updated to qualified for standard grade & updated package drawing
2.3	2016-06-13	Updated ID ratings, Zth, SOA and Pd curves

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